

128K x 8 LOW POWER CMOS STATIC RAM

DECEMBER 2017

FEATURES

- High-speed access time: 35, 45 nsLow active power: 100 mW (typical)
- Low standby power: 20 μW (typical) CMOS standby
- Output Enable (OE) and two Chip Enable (CE1 and CE2) inputs for ease in applications
- Fully static operation: no clock or refresh required
- · TTL compatible inputs and outputs
- Single 5V (±10%) power supply
- Commercial, Industrial, and Automotive temperature ranges available
- Standard Pin Configuration:
 32-pin SOP/ 32-pin TSOP (Type 1)
- Lead free available

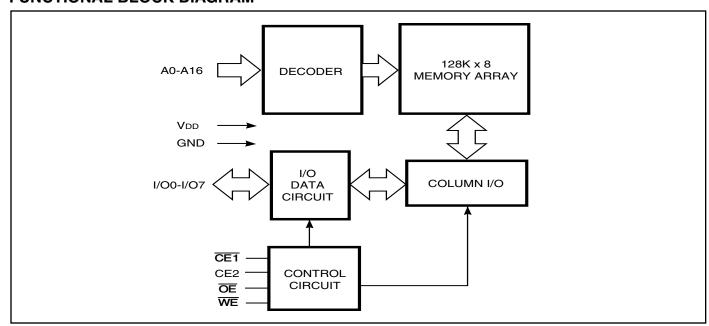
DESCRIPTION

The *ISSI* IS62C1024AL/IS65C1024AL is a low power, 131,072-word by 8-bit CMOS static RAM. It is fabricated using high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields higher performance and low power consumption devices.

When CE1 is HIGH or CE2 is LOW (deselected), the device assumes a standby mode at which the power dissipation can be reduced by using CMOS input levels.

Easy memory expansion is provided by using two Chip Enable inputs, $\overline{CE1}$ and CE2. The active LOW Write Enable (\overline{WE}) controls both writing and reading of the memory.

FUNCTIONAL BLOCK DIAGRAM



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a.) the risk of injury or damage has been minimized;

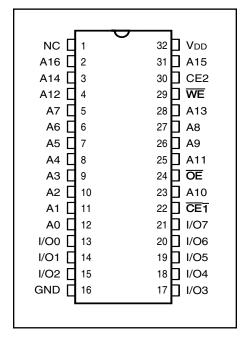
b.) the user assume all such risks; and

c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances



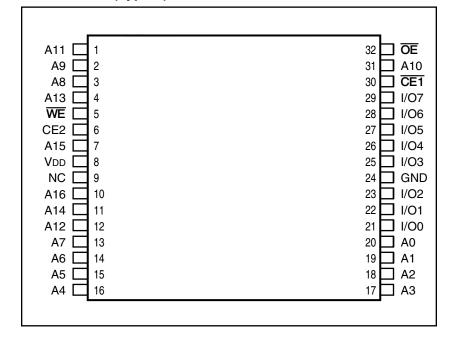
PIN CONFIGURATION

32-Pin SOP



PIN CONFIGURATION

32-Pin TSOP (Type 1)



PIN DESCRIPTIONS

| A0-A16 | Address Inputs |
|----------|---------------------|
| CE1 | Chip Enable 1 Input |
| CE2 | Chip Enable 2 Input |
| ŌĒ | Output Enable Input |
| WE | Write Enable Input |
| 1/00-1/0 | 7 Input/Output |
| VDD | Power |
| GND | Ground |

OPERATING RANGE (IS62C1024AL)

| Range | Ambient Temperature | V DD |
|------------|---------------------|-------------|
| Commercial | 0°C to +70°C | 5V ± 10% |
| Industrial | -40°C to +85°C | 5V ± 10% |

OPERATING RANGE (IS65C1024AL)

| Range | Ambient Temperature | V DD |
|------------|---------------------|-------------|
| Automotive | -40°C to +125°C | 5V ± 10% |

TRUTH TABLE

| Mode | WE | CE1 | CE2 | ŌĒ | I/O Operation | V _{DD} Current |
|-----------------|----|-----|-----|----|---------------|-------------------------|
| Not Selected | Х | Н | Х | X | High-Z | IsB1, IsB2 |
| (Power-down) | Χ | Χ | L | X | High-Z | IsB1, IsB2 |
| Output Disabled | Н | L | Н | Н | High-Z | Icc |
| Read | Н | L | Н | L | Douт | Icc |
| Write | L | L | Н | Х | Din | Icc |



ABSOLUTE MAXIMUM RATINGS(1)

| Symbol | Parameter | Value | Unit | |
|--------|--------------------------------------|--------------|------|--|
| VTERM | Terminal Voltage with Respect to GND | -0.5 to +7.0 | V | |
| Тѕтс | Storage Temperature | -65 to +125 | °C | |
| Рт | Power Dissipation | 1.0 | W | |
| Іоит | DC Output Current (LOW) | 20 | mA | |

Notes:

CAPACITANCE(1,2)

| Symbol | Parameter | Conditions | Max. | Unit | |
|--------|--------------------|------------|------|------|--|
| CIN | Input Capacitance | VIN = 0V | 6 | pF | |
| Соит | Output Capacitance | Vout = 0V | 8 | pF | |

Notes:

- 1. Tested initially and after any design or process changes that may affect these parameters.
- 2. Test conditions: $TA = 25^{\circ}C$, f = 1 MHz, VDD = 5.0V.

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

| Symbol | Parameter | Test Conditions | Options | Min. | Max. | Unit |
|--------|----------------------|---|---------|------|-----------------------|------|
| Vон | Output HIGH Voltage | $V_{DD} = Min., I_{OH} = -1.0 \text{ mA}$ | | 2.4 | | V |
| Vol | Output LOW Voltage | $V_{DD} = Min., IoL = 2.1 mA$ | | _ | 0.4 | V |
| VIH | Input HIGH Voltage | | | 2.2 | V _{DD} + 0.5 | V |
| VIL | Input LOW Voltage(1) | | | -0.5 | 0.8 | V |
| lu | Input Leakage | $GND \leq V IN \leq V DD$ | Com. | -1 | 1 | μΑ |
| | | | Ind. | -2 | 2 | |
| | | | Auto. | -5 | 5 | |
| ILO | Output Leakage | GND ≤ Vout ≤ Vdd | Com. | -1 | 1 | μΑ |
| | _ | $\overline{CE1} = V_{H}, or$ | Ind. | -2 | 2 | |
| | | $\frac{\text{CE2}}{\text{WE}} = \text{V}_{\text{IL}}, \text{ or } \overline{\text{OE}} = \text{V}_{\text{IH}} \text{ or } \overline{\text{VE}}$ | Auto. | -5 | 5 | |

Note:

ViH (max.) = VDD + 0.3V DC; ViH (max.) = VDD + 2.0V AC (pulse width -2.0 ns). Not 100% tested.

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a
stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational
sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

^{1.} V_{L} (min.) = -0.3V DC; V_{L} (min.) = -2.0V AC (pulse width -2.0 ns). Not 100% tested.



IS62C1024AL/IS65C1024AL

POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

| | | | | -35 | i ns | -4 | 5 ns | |
|--------|-----------------------|--|---------|------|------|------|------|------|
| Symbol | Parameter | Test Conditions | | Min. | Max. | Min. | Max. | Unit |
| Icc | Average operating | CE1 = VIL, CE2 = VIH | Com. | _ | 25 | | | mA |
| | Current | VIN = VIH Or VIL, | Ind. | _ | 30 | | | |
| | | $I_{I/O}=0 \text{ mA}, f=0$ | Auto. | | | _ | 35 | |
| lcc1 | VDD Dynamic Operating | V _{DD} = Max., CE1 = V _{IL} | Com. | _ | 30 | | | mA |
| | Supply Current | IOUT = 0 mA, f = fMAX | Ind. | _ | 35 | | | |
| | | VIN = VIH Or VIL | Auto. | | | _ | 40 | |
| | | CE2 = VIH | typ.(2) | | 20 | | | |
| IsB1 | TTL Standby Current | V _{DD} = Max., | Com. | _ | 1 | | | mA |
| | (TTL Inputs) | $VIN = VIH \text{ or } VIL, \overline{CE1} \ge VIH,$ | Ind. | _ | 1.5 | | | |
| | | or CE2 \leq VIL, f = 0 | Auto. | | | _ | 2 | |
| IsB2 | CMOS Standby | V _{DD} = Max., | Com. | _ | 5 | | | μA |
| | Current (CMOS Inputs) | $\overline{CE1} \ge V_{DD} - 0.2V$, or | Ind. | _ | 10 | | | |
| | | $CE2 \leq 0.2V, Vin \geq V_{DD} - 0.2V$ | , Auto. | | | _ | 45 | |
| | | or $Vin \le Vss + 0.2V$, $f = 0$ | typ.(2) | _ | 4 | | | |

Note:

READ CYCLE SWITCHING CHARACTERISTICS(1) (Over Operating Range)

| | | -35 ns | | -45 ns | | |
|-----------------------|-----------------------------|--------|------|--------|------|------|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Unit |
| trc | Read Cycle Time | 35 | _ | 45 | _ | ns |
| taa | Address Access Time | _ | 35 | _ | 45 | ns |
| tона | Output Hold Time | 3 | _ | 3 | _ | ns |
| t _{ACE1} | CE1 Access Time | _ | 35 | _ | 45 | ns |
| tace2 | CE2 Access Time | _ | 35 | _ | 45 | ns |
| tdoe | OE Access Time | _ | 10 | _ | 20 | ns |
| tlzoe(2) | OE to Low-Z Output | 3 | _ | 5 | _ | ns |
| thzoe(2) | OE to High-Z Output | 0 | 10 | 0 | 15 | ns |
| tLZCE1 ⁽²⁾ | CE1 to Low-Z Output | 3 | _ | 5 | _ | ns |
| tLZCE2 ⁽²⁾ | CE2 to Low-Z Output | 3 | _ | 5 | _ | ns |
| thzce ⁽²⁾ | CE1 or CE2 to High-Z Output | 0 | 10 | 0 | 15 | ns |

Notes

^{1.} At f = fmax, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

^{2.} Typical Values are measured at VDD = 5V, TA = 25°C and not 100% tested.

^{1.} Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0.6 to 2.4V and output loading specified in Figure 1a.

^{2.} Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.



ACTEST CONDITIONS

| Parameter | Unit |
|---|-----------------------|
| Input Pulse Level | 0.6V to 2.4V |
| Input Rise and Fall Times | 5 ns |
| Input and Output Timing and Reference Level | 1.5V |
| Output Load | See Figures 1a and 1b |

ACTEST LOADS

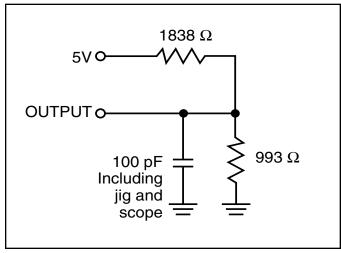


Figure 1a.

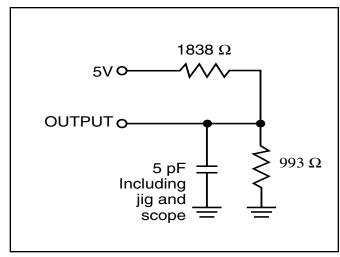
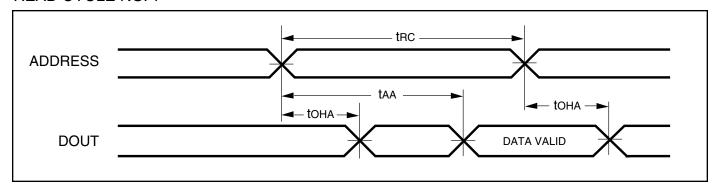


Figure 1b.

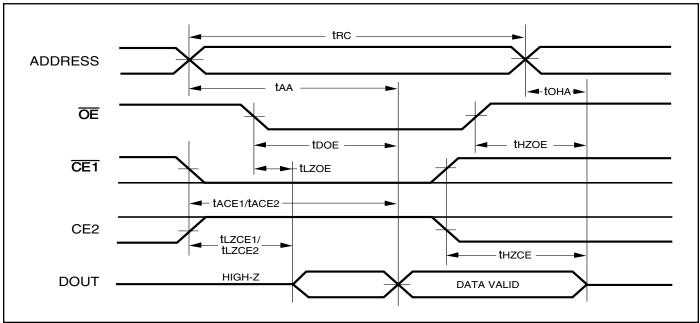
AC WAVEFORMS

READ CYCLE NO. 1^(1,2)





READ CYCLE NO. 2^(1,3)



Notes:

- 1. WE is HIGH for a Read Cycle.
- 2. The device is continuously selected. \overline{OE} , $\overline{CE1} = V_{IL}$, $CE2 = V_{IH}$.
- 3. Address is valid prior to or coincident with $\overline{CE1}$ LOW and CE2 HIGH transitions.

WRITE CYCLE SWITCHING CHARACTERISTICS^(1,3) (Over Operating Range, Standard and Low Power)

| | | -35 ns | | -45 ns | |
|----------------------|---------------------------------|--------|------|-----------------|------|
| Symbol | Parameter | Min. | Max. | Min. Max. | Unit |
| twc | Write Cycle Time | 35 | _ | 45 — | ns |
| tsce1 | CE1 to Write End | 25 | _ | 35 — | ns |
| tsce2 | CE2 to Write End | 25 | _ | 35 — | ns |
| taw | Address Setup Time to Write End | 25 | _ | 35 — | ns |
| tна | Address Hold from Write End | 0 | _ | 0 — | ns |
| tsa | Address Setup Time | 0 | _ | 0 — | ns |
| tpwE ⁽⁴⁾ | WE Pulse Width | 25 | _ | 35 — | ns |
| tsp | Data Setup to Write End | 20 | _ | 25 — | ns |
| thd | Data Hold from Write End | 0 | _ | 0 — | ns |
| thzwe ⁽²⁾ | WE LOW to High-Z Output | _ | 10 | - 15 | ns |
| tLzwe ⁽²⁾ | WE HIGH to Low-Z Output | 3 | _ | 5 — | ns |

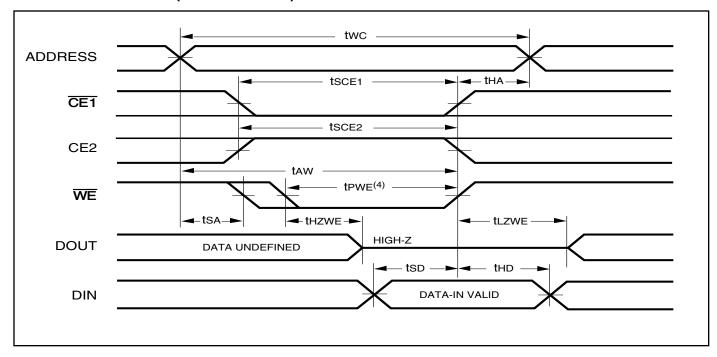
Notes:

- 1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0.6 to 2.4V and output loading specified in Figure 1a.
- 2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
- 3. The internal write time is defined by the overlap of CE1 LOW, CE2 HIGH and WE LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
- 4. Tested with OE HIGH.

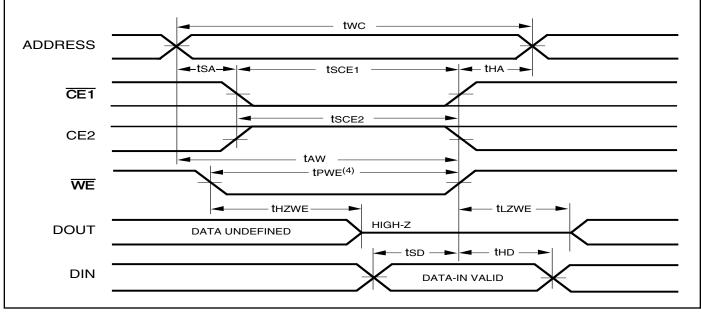


AC WAVEFORMS

WRITE CYCLE NO. 1 (WE Controlled)(1,2)



WRITE CYCLE NO. 2 (CE1, CE2 Controlled)(1,2)



Notes:

- 1. The internal write time is defined by the overlap of CE1 LOW, CE2 HIGH and WE LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
- 2. I/O will assume the High-Z state if $\overline{OE} = V_{IH}$.

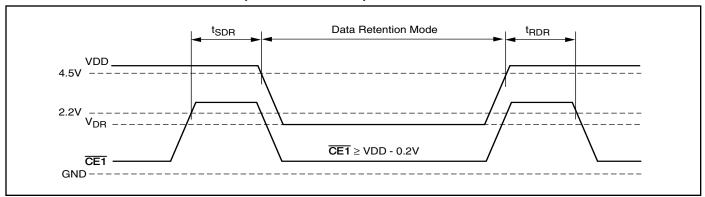


DATA RETENTION SWITCHING CHARACTERISTICS

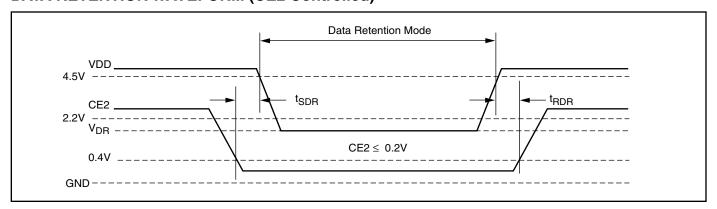
| Symbol | Parameter | Test Condition | | Min. | Тур. | Max. | Unit |
|--------|---------------------------|---|--------------|------|------|---------|------|
| VDR | VDD for Data Retention | See Data Retention Waveform | | 2.0 | | 5.5 | V |
| IDR | Data Retention Current | $V_{DD} = 2.0V, \overline{CE1} \ge V_{DD} - 0.2V$ or $CE2 \le 0.2V$ | Com. Ind. | _ | _ | 5 10 | μΑ |
| | | $V_{\text{IN}} \geq V_{\text{DD}} - 0.2V, \text{or} V_{\text{IN}} \leq V_{\text{SS}} + 0.2V$ | Auto. | _ | _ | 45 | |
| tsdr | Data Retention Setup Time | See Data Retention Waveform | | 0 | | _ | ns |
| trdr | Recovery Time | See Data Retention Waveform | | trc | | _ | ns |

Note:

DATA RETENTION WAVEFORM (CE1 Controlled)



DATA RETENTION WAVEFORM (CE2 Controlled)



^{1.} Typical Values are measured at $V_{DD} = 5V$, $T_A = 25^{\circ}C$ and not 100% tested.

IS62C1024AL IS65C1024AL



Industrial Range: -40°C to +85°C

| Speed (ns) | Order Part No. | Package |
|------------|-------------------|-------------------------|
| 35 | IS62C1024AL-35QLI | Plastic SOP, Lead-free |
| 35 | IS62C1024AL-35TLI | TSOP, Type 1, Lead-free |

ORDERING INFORMATION: IS65C1024AL Automotive Range: -40°C to +125°C

| Speed (ns) | Order Part No. | Package |
|------------|--------------------|-------------------------|
| 45 | IS65C1024AL-45QLA3 | Plastic SOP, Lead-free |
| 45 | IS65C1024AL-45TLA3 | TSOP, Type 1, Lead-free |



